

- 1 HOUSING: LCP, UL94V0, COLOR: BLACK.
CONTACT: PHOSPHOR BRONZE.
POST: BRASS WIRE
- 2 PAD CONTACT AREA: 1.27µm MIN GOLD
PCB TAILS CONTACT: 1.27µm MIN TIN-LEAD OVER
1.27µm MIN NICKEL OVER ALL
POST: 1.27µm MIN NICKEL PLATED
- 3 PLATED THROUGH HOLE PER 114-13056, FIGURE 4
- 4 SEE TABLE 1 FOR INTERCONNECTIONS TO
BACKPLANE CONNECTOR.
5. VITA 78.1 (POWER SX P2)
- 6 CONTACT: 1.27µm MIN GOLD IN PAD CONTACT AREA, 1.27µm MIN
TIN ON PCB TAIL OVER 1.27µm MIN. NICKEL OVER ALL.
POST: 1.27µm MIN NICKEL PLATED.
- 7 CONTACT: 1.27µm MIN GOLD IN PAD CONTACT AREA, 1.27µm MIN
TIN-LEAD (60/40) ON PCB TAIL OVER 1.27µm MIN. NICKEL OVER ALL.
POST: 1.27µm MIN NICKEL PLATED.

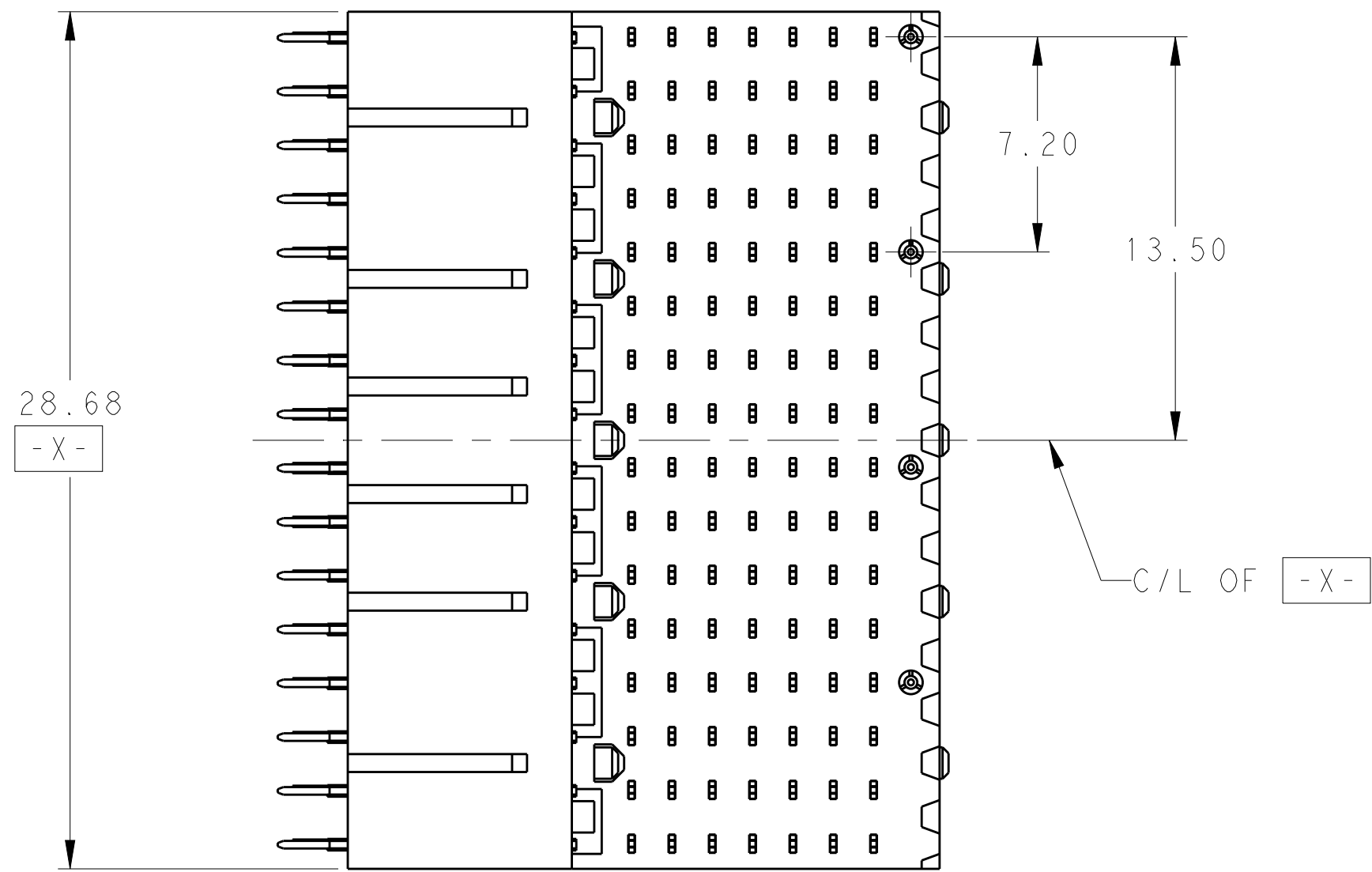
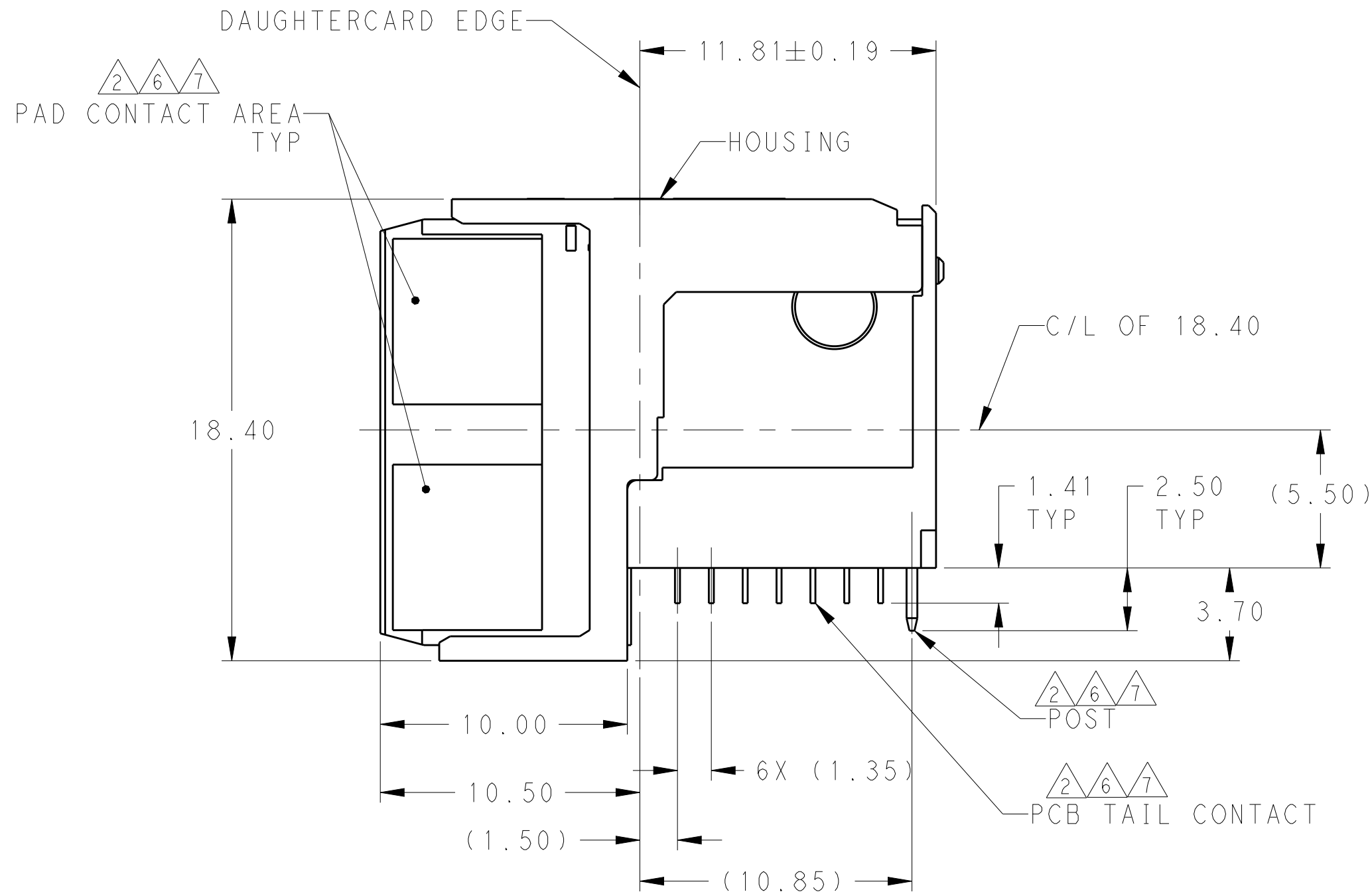
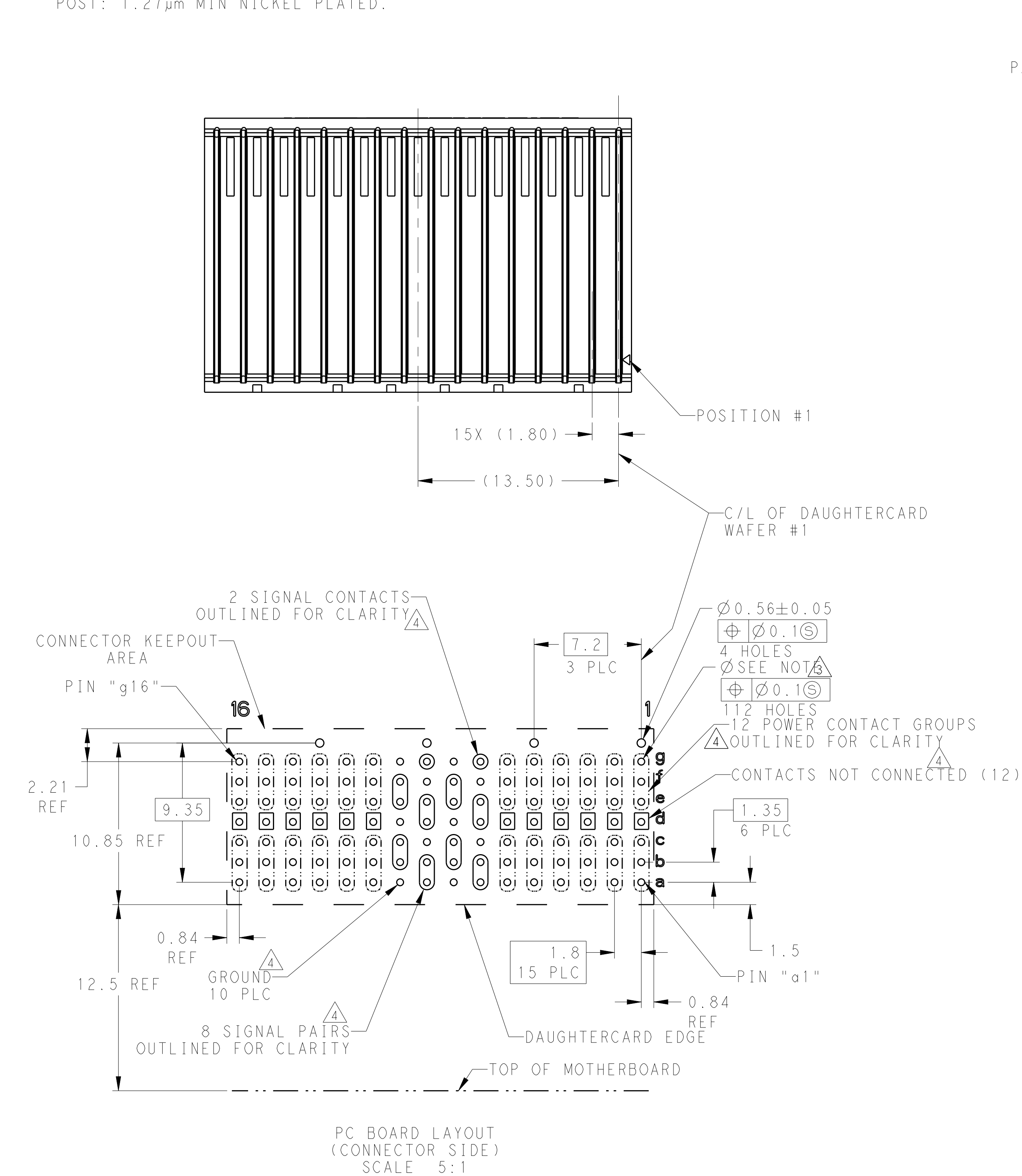


TABLE 1
INTERCONNECTIONS WITH BACKPLANE CONNECTOR

TYPICAL INTERCONNECTIONS FOR EACH COLUMN (WAFER): 1, 2, 3, 4, 5, 6, 11, 12, 13, 14, 15 & 16		
CONTACT USAGE	DAUGHTERCARD CONNECTOR PIN	BACKPLANE CONNECTOR PIN
POWER	ax, bx, cx	ax, bx, cx, dx
POWER	ex, fx, gx	fx, gx, hx, ix
Not Connect	dx	ex

TYPICAL INTERCONNECTIONS FOR EACH EVEN-NUMBERED COLUMN (WAFER): 8 & 10		
CONTACT USAGE	DAUGHTERCARD CONNECTOR PIN	BACKPLANE CONNECTOR PIN
SIGNAL PAIRS	bx	cx
	cx	dx
SIGNAL PAIRS	ex	gx
	fx	hx
GROUND	ax, dx, gx (ALL COMMONED)	ax, bx, ex, fx, ix

TYPICAL INTERCONNECTIONS FOR EACH ODD-NUMBERED COLUMN (WAFER): 7 & 9		
CONTACT USAGE	DAUGHTERCARD CONNECTOR PIN	BACKPLANE CONNECTOR PIN
SIGNAL PAIR	ax	ax
	bx	bx
SIGNAL PAIR	dx	ex
	ex	fx
SIGNAL	gx	ix
GROUND	cx, fx (ALL COMMONED)	cx, dx, gx, hx

NOTE: "x" DESIGNATES THE COLUMN NUMBER

7	2305985-3
6	2305985-2
	2305985-1
PLATING	PART NO

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN C.C. THOMAS 11-28-16	TE Connectivity	
DIMENSIONS: mm		CHK D. HOANG 11-28-16		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD D. HOANG 11-28-16	NAME	
0 PLC ±.5		PRODUCT SPEC		
1 PLC ±0.5		108-2072	SIZE CASE CODE DRAWING NO	
2 PLC ±.13		APPLICATION SPEC		
3 PLC ±.		114-13056	RESTRICTED TO	
4 PLC ±.		WEIGHT 10.33g		
ANGLES FINISH		CUSTOMER DRAWING	SCALE 5:1 SHEET 1 OF 1 REV B	
SEE TABLE				